Product

產品規格書

產品型號：SL-3.5-320480-EWMN-02

PRODUCT NO. : **SL-3.5-320480-EWMN-02**
VERSION : **Ver 1.0**
ISSUED DATE : **2023-03-24**

This module uses ROHS material

FOR CUSTOMER : _____

□ : APPROVAL FOR SPECIFICATION
■ : APPROVAL FOR SAMPLE

DATE	APPROVED BY

Solonic :

Presented by	Reviewed by	Organized by

Note:

1.Solonic Technology Co.,Ltd. reserves the right to make changes without futher notice to any products hereinto improve reliability, function or design.

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	20221008		Initial Release	

Table of Contents

1. General Description

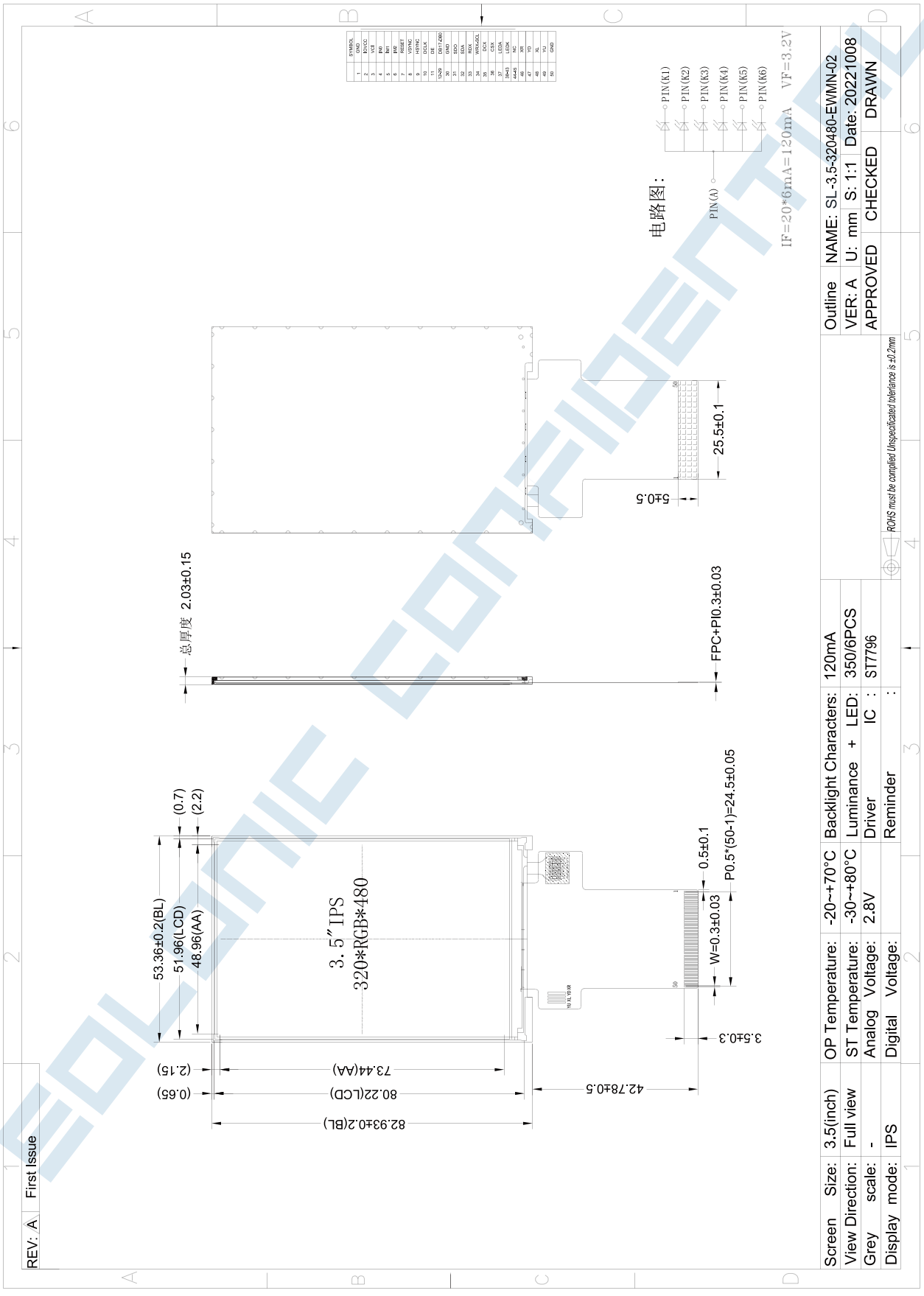
The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

Features	Details	Unit
Display Size(Diagonal)	3.5”	
LCD type	IPS TFT	
Display Mode	Transmissive /Normally black	
Resolution	320RGB x 480	Pixels
View Direction	FULL view	Best Image
Module Outline	53.36(H) x82.93(V) x 2.03 (T) (Note1)	mm
Active Area	48.96 (H) x73.44(V)	mm
Pixel Pitch	153(H) x 153(V)	um
Pixel Arrangement	RGB Vertical Stripe	
Display Colors	16.7M	
Interface	RGB+SPI	
Driver IC	ST7796	-
With or Without Touch Panel	Without	
Operating Temperature	**-20～70**	ºC
Storage Temperature	**-30～80**	ºC
Weight	-	g

2.1 outline drawing



3. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Power supply voltage	VCC	-0.3	4.6	V
	IOVCC	-0.3	4.6	V
Storage temperature	T_{STG}	**-30**	**+80**	ºC
Operating temperature	T_{OP}	**-20**	**+70**	ºC

GND =0V, Ta=25ºC

Note 1: If Ta below 50ºC, the maximal humidity is 90%RH, if Ta over 50ºC, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10℃, and the back ground will become darker at high temperature operating.

Item		Symbol	Min.	Typ.	Max.	Unit
Supply Voltage		VCC	2.5	2.8	3.3	V
		IOVCC	1.65	1.8	3.3	V
Logic Low input voltage		V_{IL}	-0.3	-	0.3*IOVCC	V
Logic High input voltage		V_{IH}	0.7*IOVCC	-	IOVCC	V
Logic Low output voltage		V_{OL}	0	-	0.2*IOVCC	V
Logic High output voltage		V_{OH}	0.8*IOVCC	-	IOVCC	V
Current Consumption All white	Logic	I_{CC+} I_{IN}	-	(20)		mA
	Analog					

4. DC Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	Ta=25 ºC, I_F=20mA/LED	**3.0**	**3.2**	**3.4**	V
Forward Current	I_F	Ta=25 ºC, V_F=3.2V/LED	-	**120**	-	mA
Power dissipation	P_D	-	-	384	-	mW
Uniformity	Avg	-	-	80	-	%
LED working life(25℃)	-		-	30,000	-	Hrs
Drive method	**Constant current**					
LED Configuration	6 White LEDs					

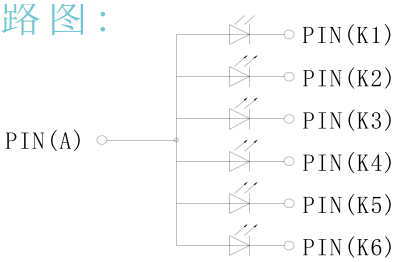
5. Backlight Characteristic

5.1. Backlight Characteristics

Note1：LED life time defined as follows: The final brightness is at 50% of original brightness.
The environmental conducted under ambient air flow, at Ta=25±2 ºC,60%RH±5%, I_F=20mA/LED.

5.2. Backlighting circuit

电路图：



6. Optical Characteristics

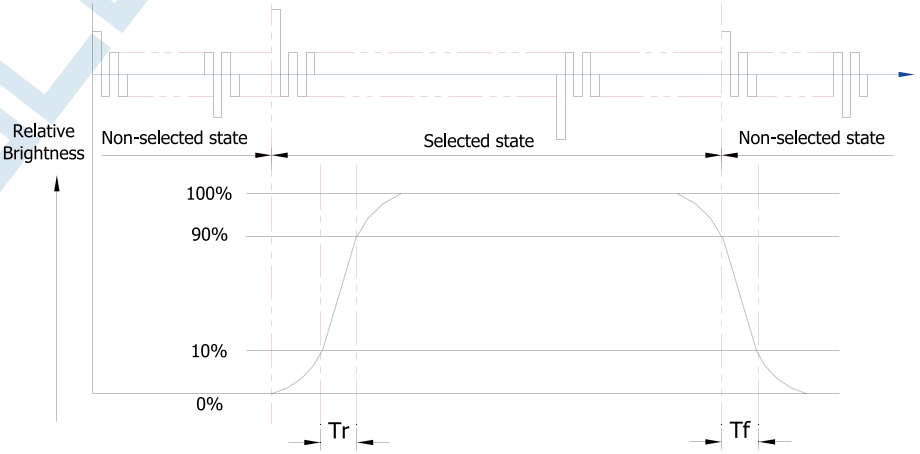
6.1. Optical Characteristics

Ta=25ºC, VCC=2.8V

	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
Backlight On (Transmissive Mode)	Luminance on TFT(I_f =20mA/LED)		Lv	Normally viewing angle θx = φy =0º	**280**	**350**	-	cd/m²
	Contrast ratio(See 7.3)		CR		800	1000	-	
	Response time (See 7.2)		TR		-	30	-	ms
			TF					
	Chromaticity Transmissive (See 7.5)	White	Xw		-	**0.295**	-	-
			Yw		-	**0.325**	-	-
	Viewing Angle (See 7.4)	Horizontal	θx+	Center CR≥10	**80**	**85**	-	Deg.
			θx-		**80**	**85**	-	
		Vertical	φy+		**80**	**85**	-	
			φy-		**80**	**85**	-	
	NTSC Ratio(Gamut)		-	-	65	70	-	%

6.2. Definition of Response Time

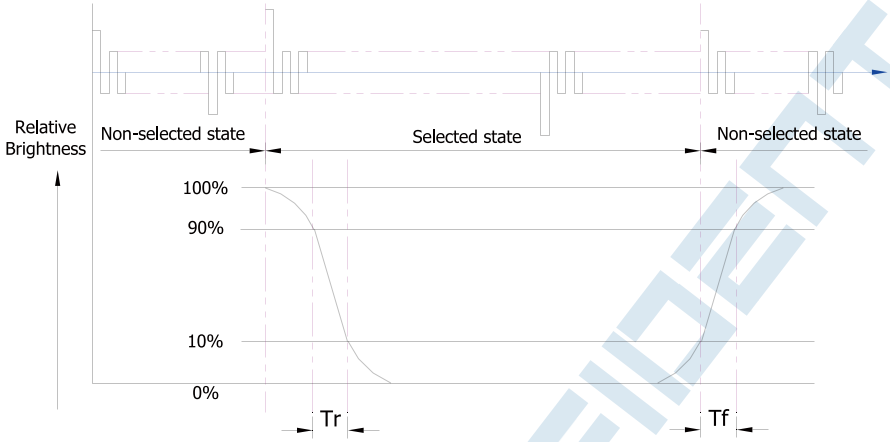
6.2.1. Normally Black Type (Negative)



Tr is the time it takes to change form non-selected stage with relative luminance 10% to

selected state with relative luminance 90%;
Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.
Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;
Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;
Note: Measuring machine: LCD-5100 or EQUI

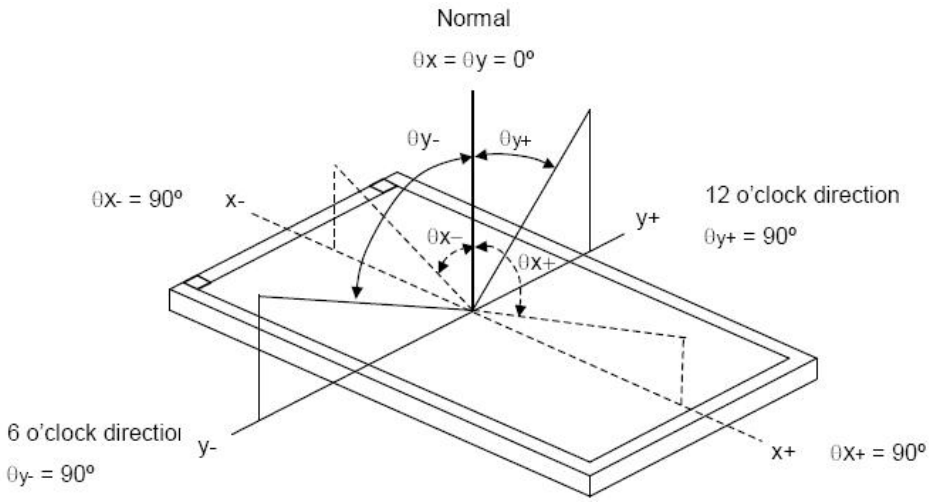
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



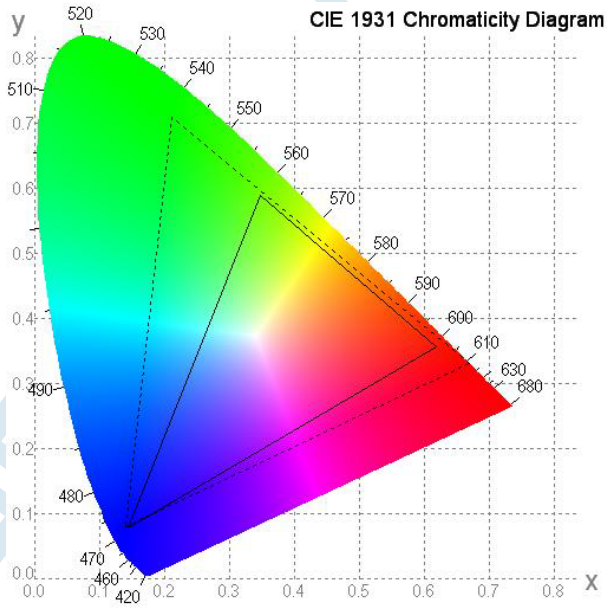
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



6.6. Definition of Surface Luminance, Uniformity and Transmittance

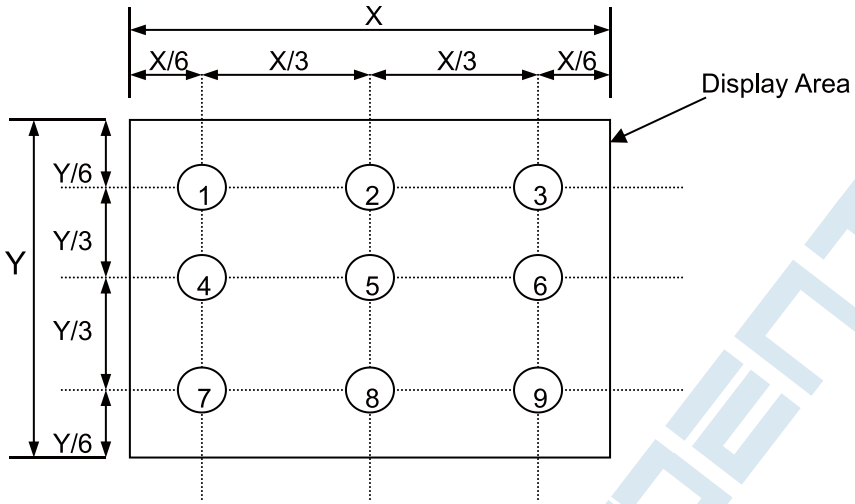
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

6.6.1. Surface Luminance: L_V = average (L_{P1}:L_{P9})

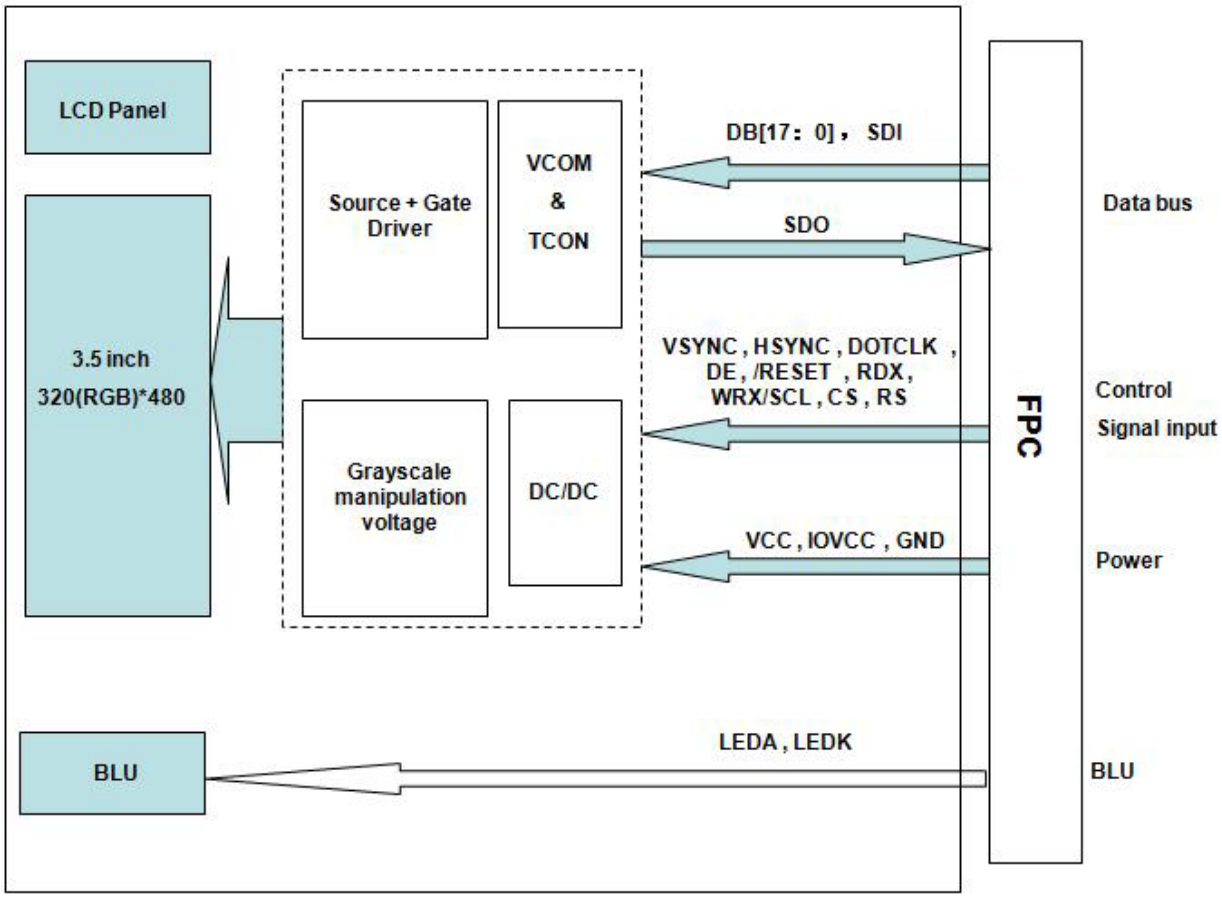
6.6.2. Uniformity = Minimal (L_{P1}:L_{P9}) / Maximal (L_{P1}:L_{P9}) * 100%

6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

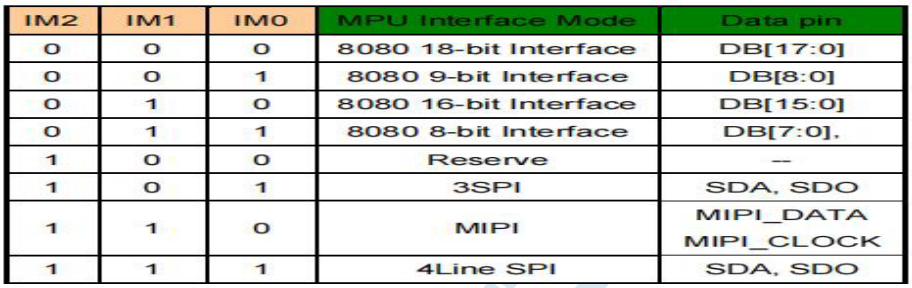
Note: Measuring machine: BM-7



7. Block Diagram and Power Supply

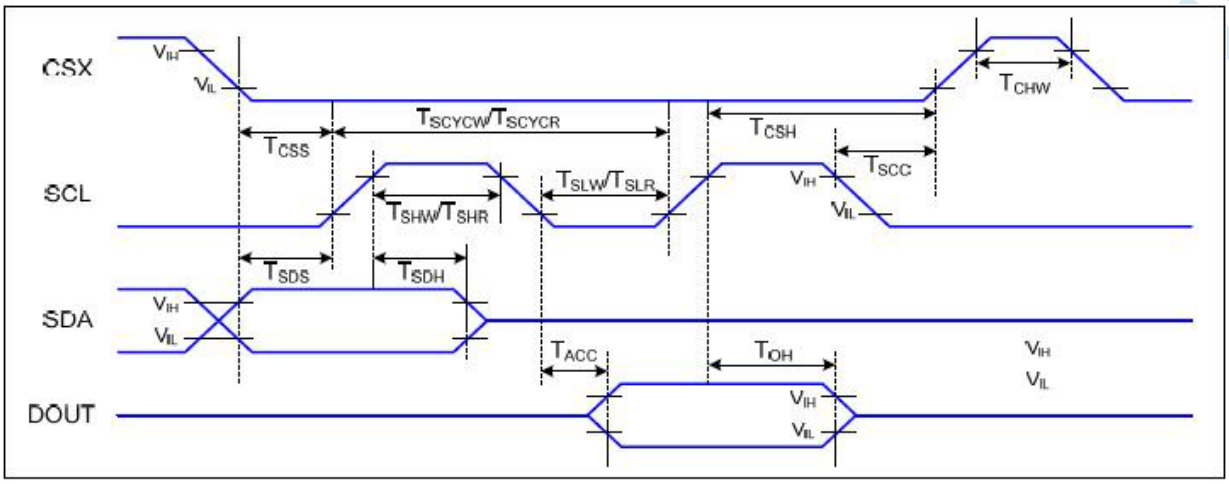


8. Interface Pins Definition

No.	Symbol	Function
1	GND	Power Ground
2	IOVCC	Power supply
3	VCI	Power supply
4	IM0	
5	IM1	
6	IM2	
7	RESET	Reset input pin. Signal is active low.
8	VSYNC	Vertical Sync Signal
9	HSYNC	Horizontal Sync Signal
10	DCLK	Pixel clock signal
11	DE	Data Enable signal.
12-29	DB17-DB0	Data bus
30	GND	Power Ground
31	SD0	Serial data output
32	SDA	Serial data input pin.
33	RDX	LCD driver read enable
34	WRX(SCL)	DBI Type B:WRX pin, serves as a write signal DBI Type C:SCL pin as Serial Clock when operates in the serial interface
35	DCX	Command/Display data selection signal
36	CSX	Chip select signal
37	LEDA	Anode for back light driver voltage
38-43	LEDK	Cathode for back light driver voltage
44-45	NC	NC
46	XR	NC
47	YD	NC
48	XL	NC
49	YU	NC
50	GND	Power Ground

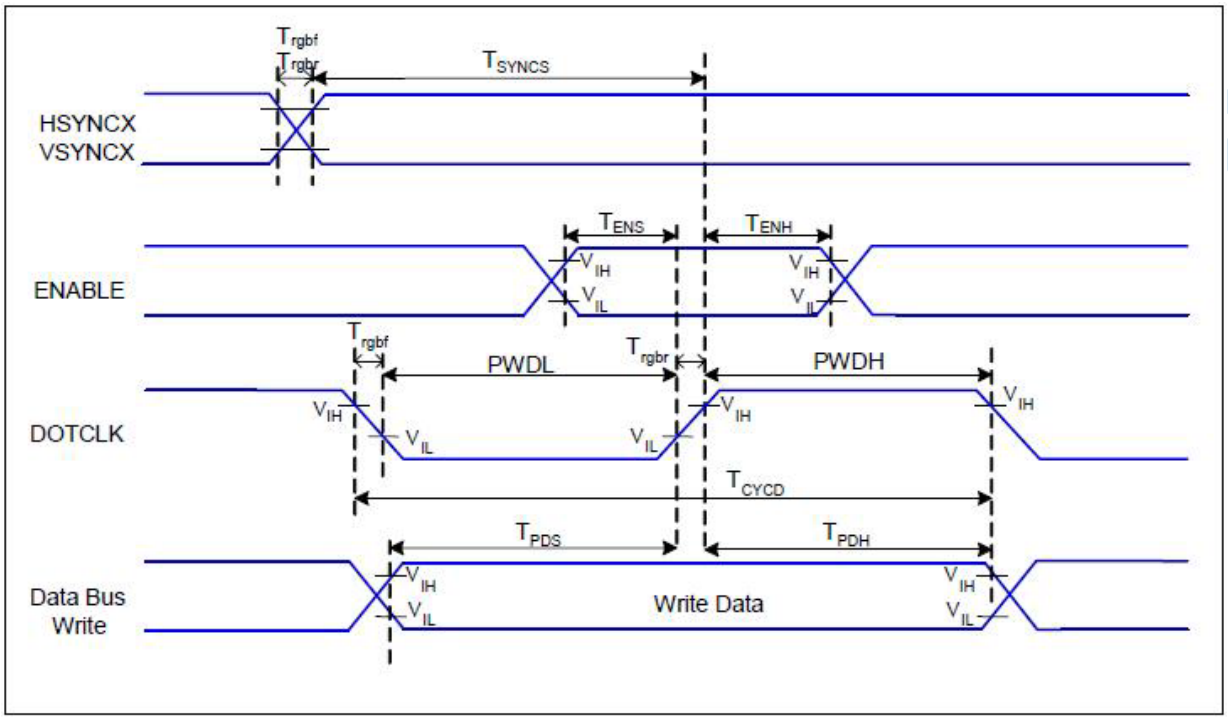
9. AC Characteristics

1）3-SPI Serial Data Transfer Interface Characteristics



Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select “H” pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	66		ns	
	T_{SHW}	SCL “H” pulse width (Write)	15		ns	
	T_{SLW}	SCL “L” pulse width (Write)	15		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	
	T_{SHR}	SCL “H” pulse width (Read)	60		ns	
	T_{SLR}	SCL “L” pulse width (Read)	60		ns	
SDA (DIN)	T_{SDS}	Data setup time	10		ns	
	T_{SDH}	Data hold time	10		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

2）RGB Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	T_{SYNCS}	VSYNC, HSYNC Setup Time	15	-	ns	
ENABLE	T_{ENS}	Enable Setup Time	15	-	ns	
	T_{ENH}	Enable Hold Time	15	-	ns	
DOTCLK	PWDH	DOTCLK High-level Pulse Width	30	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	30	-	ns	
	T_{CYCD}	DOTCLK Cycle Time	66	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	15	ns	
DB	T_{PDS}	PD Data Setup Time	15	-	ns	
	T_{PDH}	PD Data Hold Time	15	-	ns	

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2.Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5.

Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3.Nonconforming Analysis & Disposition

10.3.1. Nonconforming analysis:

10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

10.3.2. Disposition of nonconforming:

10.3.2.1. Non-conforming product over PPM level will be replaced.

10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4.Agreement Items

Shall negotiate with customer if the following situation occurs:

10.4.1. There is any discrepancy in standard of quality assurance.

10.4.2. Additional requirement to be added in product specification.

10.4.3. Any other special problem.

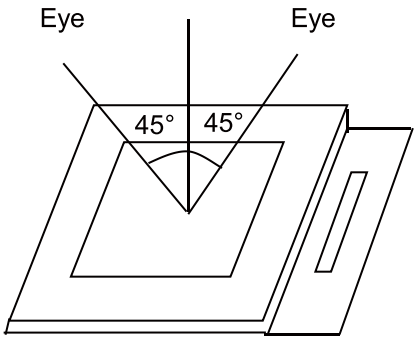
10.5.Standard of the Product Visual Inspection

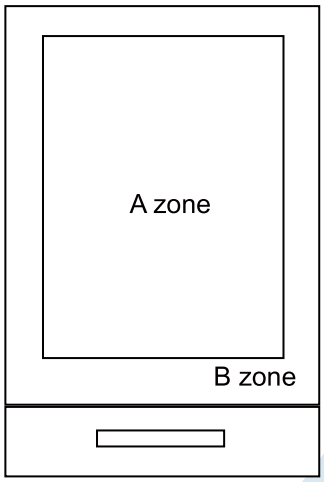
10.5.1. Appearance inspection:

10.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,



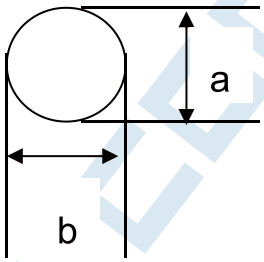


10.5.2. Basic principle:

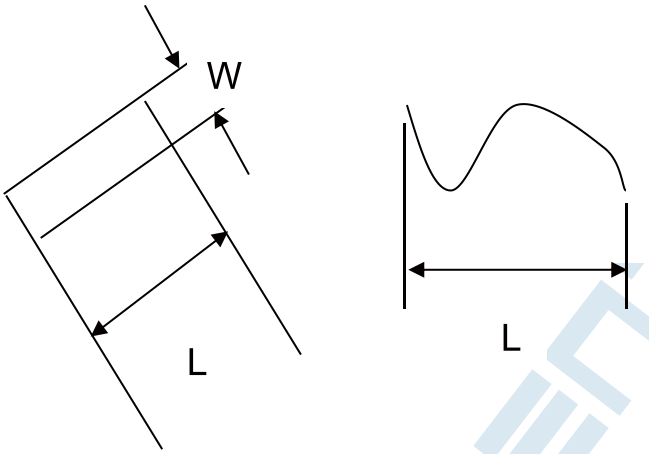
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

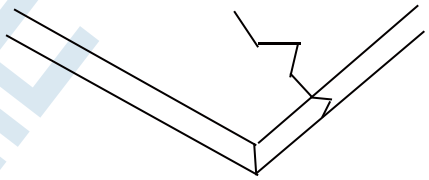
10.5.2.2. New item must be added on time when it is necessary.

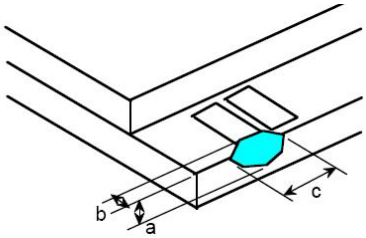
10.6.Inspection Specification

<table>
<tr><th>No.</th><th>Item</th><th>Criteria (Unit: mm)</th></tr>
<tr><td>01</td><td>Black / White spot
Foreign material
(Round type)
Pinholes
Stain
Particles inside cell.
(Minor defect)</td><td>


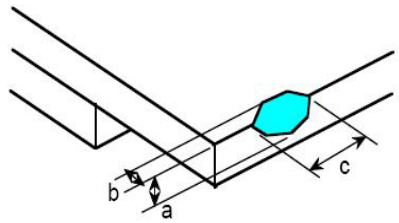
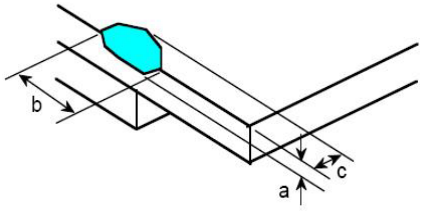
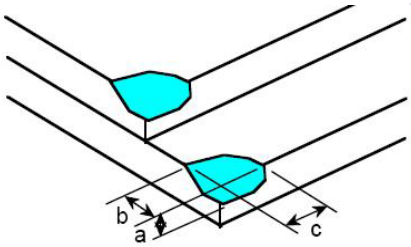
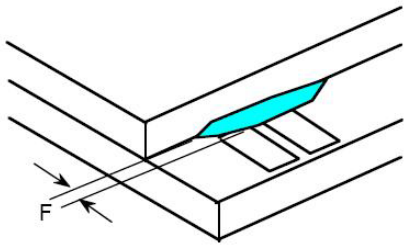
φ= (a + b) /2
<table>
<tr><th>Area / Size</th><th>Acc. Qty</th></tr>
<tr><td>φ≤0.10</td><td>Ignore</td></tr>
<tr><td>0.10<φ≤0.15</td><td>2</td></tr>
<tr><td>0.15<φ≤0.25</td><td>1</td></tr>
<tr><td>0.25<φ</td><td>0</td></tr>
<tr><td>Total</td><td>2 no include φ≤ 0.10</td></tr>
</table>
Distance between 2 defects should more than 3mm apart.
</td></tr>
<tr><td>02</td><td>Electrical Defect
(Minor defect)</td><td>
<table>
<tr><th></th><th>Display Area</th><th>Total</th><th rowspan="4">Note1</th></tr>
<tr><td>Bright dot</td><td>0</td><td>0</td></tr>
<tr><td>Dark dot</td><td>N≤2</td><td>N≤2</td></tr>
<tr><td>Total dot</td><td>N≤2</td><td>N≤2</td></tr>
<tr><td>Mura</td><td colspan="2">Not visible through 5% ND filters.</td><td>Note 2</td></tr>
</table>
Remark:
1. Bright dot caused by scratch and foreign object accords to item 1.
</td></tr>
</table>

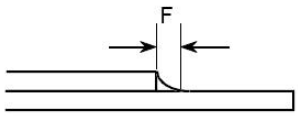
<table>
<tr>
<td>03</td>
<td>Black and White line
Scratch
Foreign material
(Line type)
(Minor defect)</td>
<td>


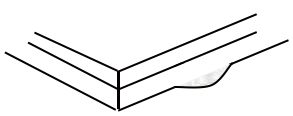
<table>
<tr><th>Length</th><th>Width</th><th>Acc. Qty</th></tr>
<tr><td>/</td><td>W ≦ 0.03</td><td>Ignore</td></tr>
<tr><td>L ≦ 2.5</td><td>0.03 ＜ W ≦ 0.05</td><td>3</td></tr>
<tr><td>L ≦ 2.5</td><td>0.05 ＜ W ≦ 0.10</td><td>2</td></tr>
<tr><td>/</td><td>0.1 ＜ W</td><td>0</td></tr>
<tr><td colspan="2">Total</td><td>3</td></tr>
</table>
Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.
</td>
</tr>
<tr>
<td>04</td>
<td>Glass Crack
(Minor defect)</td>
<td>

Crack is potential to enlarge, any type is not allowed.
</td>
</tr>
</table>

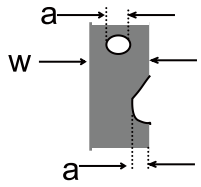
<table>
<tr>
<td>05</td>
<td>Glass Chipping Pad Area:
(Minor defect)


</td>
<td>
<table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>3</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table>
</td>
</tr>
</table>

<table>
<tr>
<td>06</td>
<td>Glass Chipping Rear of Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>07</td>
<td>Glass Chipping Except Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>08</td>
<td>Glass Corner Chipping:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c < 3.0, b< 3.0</td><td>Ignore</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>09</td>
<td>Glass Burr:
(Minor defect)
 

  </td>
<td><table>
<tr><th>Length</th><th>Acc. Qty</th></tr>
<tr><td>F < 1.0</td><td>Ignore</td></tr>
</table>
Glass burr don’t affect assemble and module dimension.</td>
</tr>
</table>

<table>
<tr><td>10</td><td>FPC Defect:
(Minor defect)
  </td><td>10.1 Dent, pinhole width a<w/3.
(w: circuitry width.)
10.2 Open circuit is unacceptable.
10.3 No oxidation, contamination and distortion.</td></tr>
<tr><td>11</td><td>Bubble on Polarizer
(Minor defect)</td><td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.20</td><td>Ignore</td></tr><tr><td>0.20 <φ≤0.30</td><td>4</td></tr><tr><td>0.30 <φ≤0.50</td><td>1</td></tr><tr><td>0.50 < φ</td><td>None</td></tr></table></td></tr>
<tr><td>12</td><td>Dent on Polarizer
(Minor defect)</td><td><table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>φ≤0.20</td><td>Ignore</td></tr><tr><td>0.20 <φ≤0.30</td><td>4</td></tr><tr><td>0.30 <φ≤0.50</td><td>1</td></tr><tr><td>0.50 < φ</td><td>None</td></tr></table></td></tr>
<tr><td>13</td><td>Bezel</td><td>13.1 No rust, distortion on the Bezel.
13.2 No visible fingerprints, stains or other contamination.</td></tr>
<tr><td>14</td><td>PCB</td><td>15.1 No distortion or contamination on PCB terminals.
15.2 All components on PCB must same as documented on the BOM/component layout.
15.3 Follow IPC-A-600F.</td></tr>
<tr><td>15</td><td>Soldering</td><td>Follow IPC-A-610C standard</td></tr>
<tr><td>16</td><td>Electrical Defect
(Major defect)</td><td>The below defects must be rejected.
17.1 Missing vertical / horizontal segment,
17.2 Abnormal Display.
17.3 No function or no display.
17.4 Current exceeds product specifications.
17.5 LCD viewing angle defect.
17.6 No Backlight.
17.7 Dark Backlight.
17.8 Touch Panel no function.</td></tr>
</table>

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7.Classification of Defects

10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

10.7.2. Two minor defects are equal to one major in lot sampling inspection.

10.8.Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

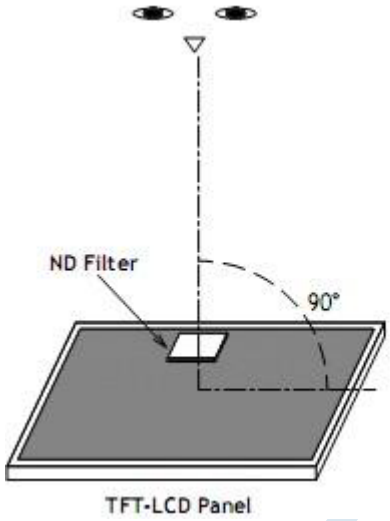
10.9.Packing

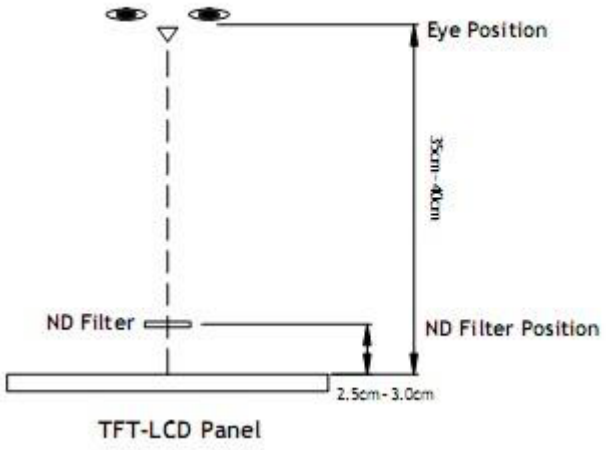
10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.

10.9.2. Modules inside package box should have compliant mark.

10.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.





Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	**70℃, 240Hrs**	2	GB/T2423.2 -2008
2	Low Temperature Operating	**-20℃, 240Hrs**	2	GB/T2423.1 -2008
3	High Humidity	**60℃, 90%RH, 240Hrs**	2	GB/T2423.3 -2016
4	High Temperature Storage	**80℃, 240Hrs**	2	GB/T2423.2 -2008
5	Low Temperature Storage	**-30℃, 240Hrs**	2	GB/T2423.1 -2008
6	Thermal Cycling Test	**-30℃, 60min~80℃, 60min, 100 cycles.**	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air:±4KV 150pF/330Ω 5 times Contact:±2KV 150pF/330Ω 5 times	2	GB/T17626.2 -2018
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1.Safety

12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2.Handling

12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.

12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3.Storage

12.3.1. Do not store the LCD module beyond the specified temperature ranges.

12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4.Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

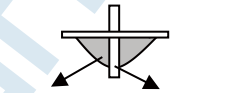
Maximum Solder Temperature: 370℃

Maximum Solder Time: 3s at the maximum temperature

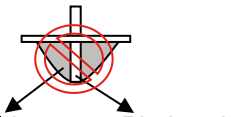
Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



Recommended



Not Recommended

12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270～290℃

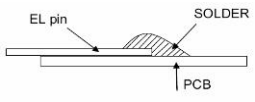
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

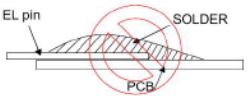
12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

12.4.2.6. Solder Wetting

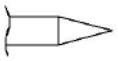


Recommended

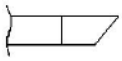


Not Recommended

12.4.2.7. The type of the solder iron:

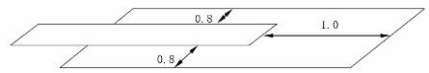


Recommended



Not Recommended

12.4.2.8. Solder Pad



12.5.Operation

12.5.1. Do not drive LCD with DC voltage
12.5.2. Response time will increase below lower temperature
12.5.3. Display may change color with different temperature
12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.
12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
12.5.8. Do not display the fixed pattern for long time（we suggest the time not longer than one hour） because it may develop image sticking due to the TFT structure.

12.6.Static Electricity

12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
12.6.2. The normal static prevention measures should be observed for work clothes and benches.
12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7.Limited Warranty

12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

13. Packaging

TBD